## FEATURES

Guaranteed AC performance over temp and voltage:

- DC-to-800MHz f MAX
- <100ps IN-to-OUT $\mathrm{t}_{\text {pd }}$

■ Ultra-low jitter design:

- $<1 \mathrm{ps}_{\text {RMs }}$ random jitter
- <10ps ${ }_{\text {pp }}$ deterministic jitter
- <1ps ${ }_{\text {RMS }}$ cycle-to-cycle jitter
- $<1 \mathrm{ps}_{\mathrm{pp}}$ total jitter (clock)

■ Differential LVPECL output

- ICC max. 20mA

■ Q output will default HIGH with inputs open

- Power supply $3.3 \mathrm{~V} \pm 10 \%$ or $5.0 \mathrm{~V} \pm 10 \%$
- $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ temperature range
- Available in ultra-small 8 -pin ( $2 \mathrm{~mm} \times 2 \mathrm{~mm}$ ) MLF ${ }^{\text {TM }}$ package


## APPLICATIONS

■ High-speed logic

- Data communications systems

■ Wireless communications systems
■ Telecom systems

## FUNCTIONAL BLOCK DIAGRAM

LVPECL


8 -Pin MLF ${ }^{\text {TM }}(2 \mathrm{~mm} \times 2 \mathrm{~mm})$

TYPICAL APPLICATIONS CIRCUIT



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## PACKAGE/ORDERING INFORMATION

Ordering Information


8-Pin MLF ${ }^{\text {TM }}$

## PIN DESCRIPTION

| Pin Number | Pin Name | Pin Function |
| :---: | :---: | :--- |
| 7 | IN | Single-ended input: This is the LVTTL/LVCMOS input to the device. Input switching <br> threshold is $\mathrm{V}_{\mathrm{CC}} / 2$. If left floating, Q output will default HIGH. |
| 8 | VCC | Positive power supply. Bypass with $0.1 \mu \mathrm{~F} \\| 0.01 \mu \mathrm{~F}$ low ESR capacitors. |
| 2,3 | Q, /Q | Differential LVPECL output: This output is the output of the device. Terminate with $50 \Omega$ to <br> $\mathrm{V}_{\text {CC }}-2 \mathrm{~V}$. See "Output Interface Applications" section. Defaults HIGH if IN is floating. |
| 5 | GND, <br> Exposed Pad | Ground: Ground pin and exposed pad must be connected to the same ground plane. |
| $1,4,6$ | NC | No connect. |


| Absolute Maximum Ratings ${ }^{(1)}$ |
| :---: |
| Supply Voltage ( $\mathrm{V}_{\mathrm{CC}}$ ) ............................ -0.5 V to +4.0 V |
| Input Voltage ( $\mathrm{V}_{\text {IN }}$ ) .................................... -0.5 V to $\mathrm{V}_{\mathrm{CC}}$ |
| LVPECL Output Voltage ( $\mathrm{V}_{\text {OUT }}$ ) .... $\mathrm{V}_{\mathrm{CC}}-1.0 \mathrm{~V}$ to $\mathrm{V}_{\text {CC }}+0.5 \mathrm{~V}$ |
| LVPECL Output Current (IOUT) |
| Continuous ....................................................50mA |
| Surge ............................................................. 100 mA |
| Input Current |
| Source or sink current on IN ........................... $\pm 50 \mathrm{~mA}$ |
| Lead Temperature (soldering, 20 sec .) ................. $+260^{\circ} \mathrm{C}$ |
| Storage Temperature ( $\mathrm{T}_{\mathrm{S}}$ ) .................... $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ |

## Operating Ratings ${ }^{(2)}$

Supply Voltage ( $\mathrm{V}_{\mathrm{CC}}$ ) ..... 3.0 V to 3.3 V
4.5 V to 5.5 V
Ambient Temperature ( $\mathrm{T}_{\mathrm{A}}$ ) ..... $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
Package Thermal Resistance ${ }^{(3)}$
MLF ${ }^{\text {TM }}\left(\theta_{J A}\right)$$93^{\circ} \mathrm{C} / \mathrm{W}$
500lfpm ..... $87^{\circ} \mathrm{C} / \mathrm{W}$
$\mathrm{MLF}^{T M}\left(\Psi_{\mathrm{JB}}\right)$
Junction-to-board ..... $32^{\circ} \mathrm{C} / \mathrm{W}$

## DC ELECTRICAL CHARACTERISTICS(4)

| Symbol | Parameter | Condition | Min | Typ | Max | Units |
| :--- | :--- | :--- | :---: | :---: | :---: | :---: |
| $\mathrm{V}_{\mathrm{CC}}$ | Power Supply |  | 3.0 | 3.3 | 3.6 | V |
|  |  |  | 4.5 | 5.0 | 5.5 | V |
| $\mathrm{I}_{\mathrm{CC}}$ | Power Supply Current | No load, max. $\mathrm{V}_{\mathrm{CC}}$ |  |  | 20 | mA |

## LVTTL/LVCMOS ELECTRICAL CHARACTERISTICS(4)

$\mathrm{T}_{\mathrm{A}}=-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$; Unless otherwise stated.

| Symbol | Parameter | Condition | Min | Typ | Max |
| :--- | :--- | :--- | :---: | :---: | :---: |
| $\mathrm{V}_{\mathrm{IH}}$ | Input HIGH Voltage <br> $(\mathrm{IN}, / \mathrm{IN})$ |  | 2.0 |  |  |
| $\mathrm{~V}_{\mathrm{IL}}$ | Input LOW Voltage <br> $(\mathrm{IN}, / \mathrm{IN})$ |  | V |  |  |
| $\mathrm{I}_{\mathrm{IH}}$ | Input HIGH Current | $\mathrm{V}_{\mathrm{IN}}=2.7 \mathrm{~V}$ |  | 0.8 |  |
|  |  | $\mathrm{~V}_{\mathrm{IN}}=\mathrm{V}_{\mathrm{CC}}$ | V |  |  |
| $\mathrm{I}_{\mathrm{IL}}$ | Input LOW Current | $\mathrm{V}_{\mathrm{IN}}=0.5 \mathrm{~V}$ |  | 20 | $\mu \mathrm{~A}$ |
| $\mathrm{~V}_{\mathrm{IK}}$ | Input Clamp Voltage | $\mathrm{I}_{\mathrm{IN}}=-18 \mathrm{~mA}$ |  | 100 | $\mu \mathrm{~A}$ |

## LVPECL OUTPUTS DC ELECTRICAL CHARACTERISTICS(4)

$\mathrm{V}_{\mathrm{CC}}=3.3 \mathrm{~V} \pm 10 \%$ or $5 \mathrm{~V} \pm 10 \%$; $\mathrm{T}_{\mathrm{A}}=-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C} ; \mathrm{R}_{\mathrm{L}}=50 \Omega$ to $\mathrm{V}_{\mathrm{CC}}-2 \mathrm{~V}$, or equivalent, unless otherwise stated.

| Symbol | Parameter | Condition | Min | Typ | Max | Units |
| :--- | :--- | :--- | :---: | :---: | :---: | :---: |
| $\mathrm{V}_{\text {OH }}$ | Output HIGH Voltage <br> $\mathrm{Q}, / \mathrm{Q}$ | Note 2 | $\mathrm{V}_{\mathrm{CC}}-1.080$ |  | $\mathrm{~V}_{\mathrm{CC}}-0.880$ | V |
| $\mathrm{~V}_{\text {OL }}$ | Output LOW Voltage <br> $\mathrm{Q}, / \mathrm{Q}$ |  | $\mathrm{V}_{\mathrm{CC}}-1.830$ |  | $\mathrm{~V}_{\mathrm{CC}}-1.550$ | V |
| $\mathrm{~V}_{\text {OUT }}$ | Output Voltage Swing <br> $\mathrm{Q}, / \mathrm{Q}$ | See Figure 1a. | 600 | 800 |  | mV |
| $\mathrm{V}_{\text {DIFF-OUT }}$ | Differential Output Voltage Swing <br> $\mathrm{Q}, / \mathrm{Q}$ | See Figure 1b. | 1200 | 1600 |  | mV |

Notes:

1. Permanent device damage may occur if the "Absolute Maximum Ratings" are exceeded. This is a stress rating only and functional operation is not implied at conditions other than those detailed in the operational sections of this data sheet. Exposure to the absolute maximum ratings conditions for extended periods may affect device reliability.
2. The data sheet limits are not guaranteed if the device is operated beyond the operating ratings.
3. Package Thermal Resistance assumes exposed pad is soldered (or equivalent) to the devices most negative potential on the PCB. $\Psi_{\mathrm{JB}}$ uses 4-layer $\theta_{J A}$ in still-air unless otherwise stated.
4. The circuit is designed to meet the DC specifications shown in the above table after thermal equilibrium has been established.

## AC ELECTRICAL CHARACTERISTICS (5)

$\mathrm{V}_{\mathrm{CC}}=3.3 \mathrm{~V} \pm 10 \%$ or $5.0 \mathrm{~V} \pm 10 \% ; \mathrm{T}_{\mathrm{A}}=-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$, unless otherwise stated.

| Symbol | Parameter | Condition | Min | Typ | Max | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{f}_{\text {MAX }}$ | Maximum Operating Frequency | $\mathrm{V}_{\text {OUT }} \geq 350 \mathrm{mV}$ |  |  | 800 | MHz |
| $t_{\text {pd }}$ | Propagation Delay IN-to-Q, /IN-to-/Q |  | 100 |  | 600 | ps |
| $\mathrm{t}_{\text {JITTER }}$ | Random Jitter (RJ) | Note 6 |  |  | 1 | $\mathrm{ps}_{\mathrm{RMS}}$ |
|  | Deterministic Jitter (DJ) | Note 7 |  |  | 10 | pSPP |
|  | Cycle-to-Cycle Jitter | Note 8 |  |  | 1 | $\mathrm{pS}_{\text {RMS }}$ |
|  | Total Jitter (TJ) | Note 9 |  |  | 25 | pSPP |
| $t_{r}, t_{f}$ | Rise / Fall Time (20\% to 80\%) $\mathrm{Q}, / \mathrm{Q}$ | At full output swing. | 200 |  | 500 | ps |

## Notes:

5. Measured with outputs loaded with $50 \Omega$ to $\mathrm{V}_{\mathrm{CC}}-2 \mathrm{~V}$ unless otherwise stated. See "Timing Diagrams" section for definition of parameters. Highfrequency AC-parameters are guaranteed by design and characterization.
6. RJ is measured with a K28.7 comma detect character pattern, measured at $f_{\text {MAX }}$.
7. DJ is measured at $f_{\text {MAX }}$, with both K 28.5 and $2^{23}-1$ PRBS pattern
8. Cycle-to-cycle jitter definition: the variation of periods between adjacent cycles, $\mathrm{Tn}-\mathrm{Tn}-1$ where T is the time between rising edges of the output signal.
9. Total jitter definition: with an ideal clock input of frequency $\leq f_{\text {MAX }}$, no more than one output edge in $10^{12}$ output edges will deviate by more than the specified peak-to-peak jitter value.

## SINGLE-ENDED AND DIFFERENTIAL SWING



Figure 1a. Single-Ended Voltage Swing


Figure 1b. Differential Voltage Swing

## TIMING DIAGRAM



Figure 2. Timing Diagram

## OUTPUT INTERFACE APPLICATIONS



Figure 3a. Parallel Thevenin-Equivalent Termination


Figure 3b. Three-Resistor Termination


Figure 3c. Terminating Unused I/O

## RELATED PRODUCT AND SUPPORT DOCUMENTATION

| Part Number | Function | Data Sheet Link |
| :--- | :--- | :--- |
| SY89322V | 3.3V/5V Dual LVTTL/LVCMOS-to-Differential <br> LVPECL Translator | www.micrel.com/product-info/products/sy89322v.shtml |
|  | MLF ${ }^{\text {TM }}$ Application Note | www.amkor.com/products/notes_papers/MLF_AppNote_0902.pdf |
| HBW Solutions | New Products and Applications | www.micrel.com/product-info/products/solutions.shtml |

## 8 LEAD MicroLeadFrame (MLF-8)



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